NSN 5962-01-330-0703

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-01-330-0703 **Body Length:** Between 0.484 inches and 0.496 inches **Body Width:** Between 0.284 inches and 0.296 inches **Body Height:** Between 0.070 inches and 0.090 inches **Maximum Power Dissipation Rating:** 495.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Monolithic and high performance and static operation **Inclosure Material:** Ceramic **Inclosure Configuration:** Leadless flat pack **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Input Circuit Pattern:** 20 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 5.5 volts power source **Memory Device Type:** Rom **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 22 leadless Shelf Life: N/a **Unit Of Measure: Demilitarization:** Yes - demil/mli

Fiig:

A458a0